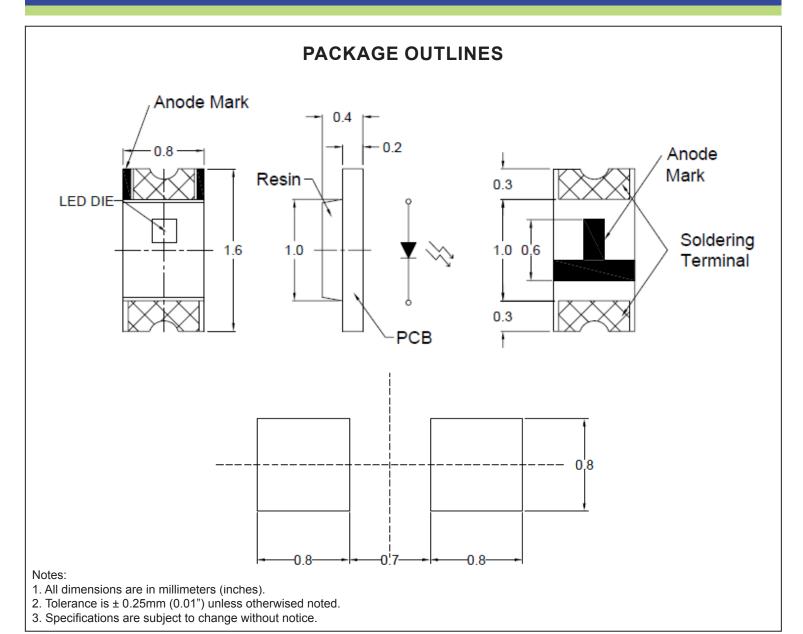


# SPECIFICATION CS63CGT1C2MA



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CS63CGT1C2MA	InGaN	Green	Water Clear	130°	





## **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	50	μA	
Power Dissipation	Pd	108	mW	
Operating Temperature Range	Тор	-20~+80	°C	
Storage Temperature Range	Тѕтс	-30~+100	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lFP	100	mA	
Soldering Temperature	TsoL	Max 260°C for 5 sec Max		

## **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

Deremeter	Symbol	Test Condition	Value			Linit
Parameter			Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 2mA	20	32	-	mcd
Forward Voltage	VF	IF = 2mA	-	2.9	3.2	V
Reverse Leakage Current	lR	VR = 5V	-	10	-	μΑ
Viewing Angle at 50% Iv	201/2	IF = 2mA	-	130	-	Deg
Dominant Wavelength	λD	IF = 2mA	-	525	-	nm

<sup>\*</sup>Tolerance of viewing angle: -10 / +5 deg.





### **OPTICAL CHARACTERISTIC CURVES**

Fig.1 Forward current vs. Forward Voltage

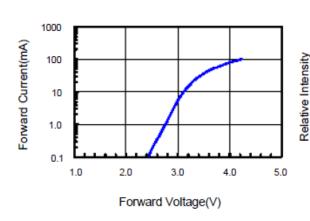


Fig.2 Relative Intensity vs. Forward Current

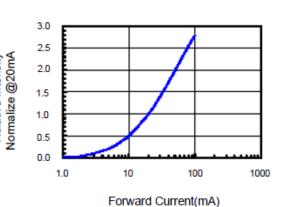


Fig.3 Forward Voltage vs. Temperature

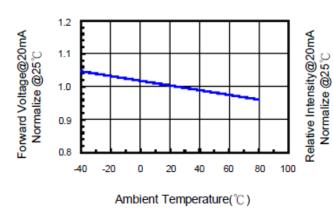


Fig.4 Relative Intensity vs. Temperature

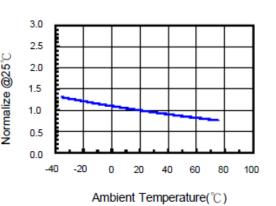


Fig.5 Relative Intensity vs. Wavelength

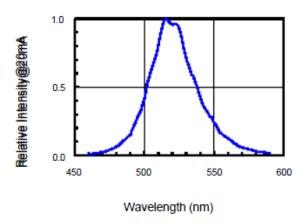
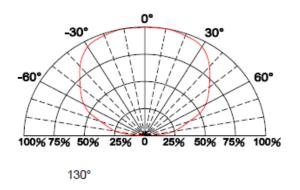


Fig.6 Directive Radiation

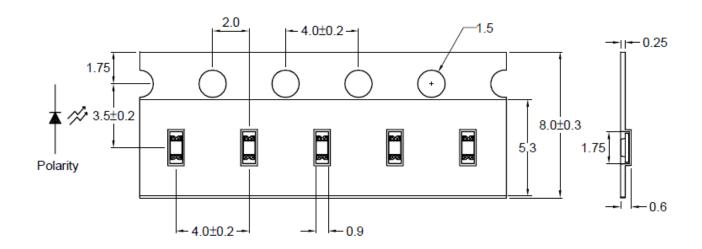




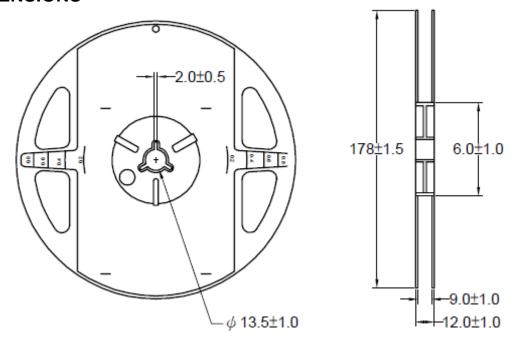


## **PACKAGING SPECIFICATION**

### **Dimensions of Tape (Unit: mm)**



#### **REEL DIMENSIONS**



#### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 4,000pcs/Reel



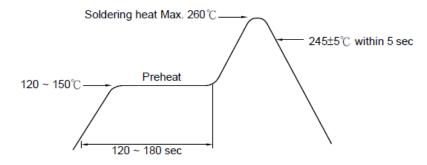


## **SOLDERING CONDITIONS**

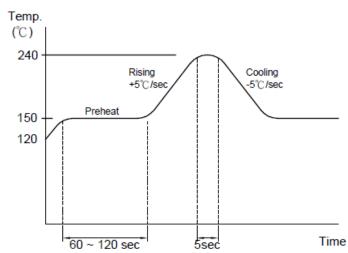
#### Hand Solder

Basic spec is  $\leq 280^{\circ}$ C 3 sec one time only.

#### 2. Wave Solder



#### 3-1. LEAD Reflow Solder



#### 3-2 PB-Free Reflow Solder

